

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





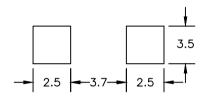


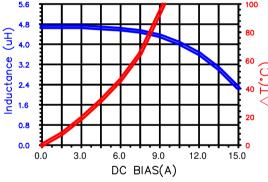
MGV06034R7M-10

PHYSICAL DIMENSIONS:

Α	7.30	±	0.50
В	6.70	±	0.30
С	3.00	±	0.30
D	2.90	±	0.30
Ε	1.60	<u>+</u>	0.50

LAND PATTERNS FOR REFLOW SOLDERING

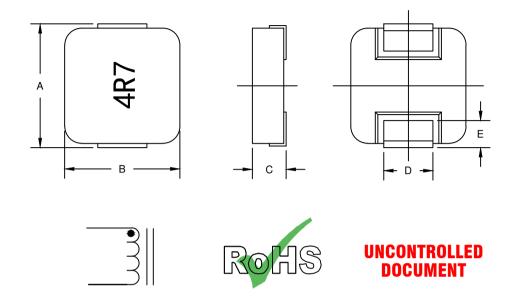




ELECTRICAL SPECIFICATION @ 25°C

	Min	Norm	Max
INDUCTANCE (uH) L @ 100 KHz/0.25V ± 20%	3.76	4.7	5.64
DCR (Ω)			0.040

Saturation Current ³ Isat (A)	10.00
Temperature Rise Current Irms ⁴ (A)	5.50



NOTES: UNLESS OTHERWISE SPECIFIED

- 1.COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 2.OPERATION TEMPERATURE RANGE: -40°C~+125°C (INCLUDING SELF-HEATING).
- 3.DEFINITION OF SATURATION CURRENT (ISAT): DC CURRENT AT WHICH THE INDUCTANCE DROPS $\leq 25\%$ FROM ITS VALUE WITHOUT CURRENT (Ta=25 \pm 5°C).
- 4.DEFINITION OF TEMPERATURE RISE CURRENT (IRMS): DC CURRENT THAT CAUSES THE TEMPERATURE RISE ($\Delta T \leq 40^{\circ}C$) FROM 25°C AMBIENT.

DIMENSIONS ARE IN mm.				This print is the property of Lai	d			
				Tech, and is loaned in confidence subject to return upon request with the understanding that no	e and	Laird		
G	UPDATE LOGO	04/22/15	QIU	written consent of Laird Tech. All rights to design or invention are				
F	CHANGE NOTE 2.3.4	06/24/12	QIU					
E	REVISE DIMENSIONS AND ADD CURVE	06/27/12	QIU	reserved.				
D	CORRECT MARKING AND DIMENSION	03/21/12	I QIU	PROJECT/PART NUMBER:	REV	PART TO	PE: WER	DRAWN BY:
С	C CHANGE FROM 3	03/16/12	QIU	MGV06034R7M-10) G		CTOR QIU	
В	CHG IAMENSION AND ADD NOTE 2&3	02/21/12	QIU	DATE: 12/19/11	SCALE:	NTS	SHEET:	
Α	ORIGINAL DRAFT	12/19/11	QIU		TOOL #	113	_	
REV	DESCRIPTION	DATE	INT	MGV06034R7M-10-G	· #	_	1	of 1